

### **SMT1450**

## High Performance Infrared TOP NIR LED

SMT1450 consists of an InGaAsP LED mounted on the lead frame as TOP LED package It is sealed with epoxy resin. It emits a spectral band of radiation at 1450nm.

<Specifications>

Product Name: TOP NIR LED
 Type Number: SMT1450

Chip:

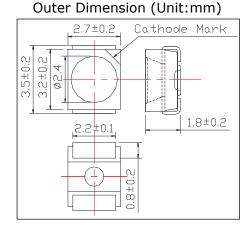
Chip Material: InGaAsP Peak Wavelength: 1450nm

4. Package

5. Lead Frame Die: Silver Plated

- Package Resin: PA6T

- Lens: Epoxy or Solicone Resin



Absolute Maximum Ratings[Ta=25°C]			
Item	Symbol	Maximum Rated Value	Unit
Power Dissipation	PD	130	mW
Forward Current	IF	100	mA
Pulse Forward Current*	IFP	1000	mA
Reverse Voltage	VR	5	V
Thermal Resistance	Rthja	80	K/W
Junction Temperature	Tj	120	°C
Operating Temperature	TOPR	-40 ~ +85	°C
Storage Temperature	TSTG	-40 ~ +100	°C
Soldering Temperature**	TSOL	250 °C	

<sup>\*</sup> Duty=1% and Pulse Width=10us.

<sup>\*\*</sup>Soldering condition must be completed within 5 second at 250 °C.

Electro-Optical Characteristics [Ta=25°C]								
Item	Symbol	Condition	Minimum	Typical	Maximum	Unit		
Forward Voltage	VF	IF=50mA		0.9	1.3	V		
	VFP	IFP=500mA		1.7				
Radiated Power*	РО	IF=50mA		2.5		mW		
		IFP=500mA		13				
Radiant Intensity**	IE	IF=50mA		2.5		mW/sr		
		IFP=500mA		13				
Peak Wavelength	λP	IF=50mA	1400		1500	nm		
Half Width	Δλ	IF=50mA		110		nm		
Viewing Half Angle	θ1/2	IF=50mA		±63		deg		
Rise Time	tr	IF=50mA		80		ns		
Fall TIme	tf	IF=50mA		30		ns		

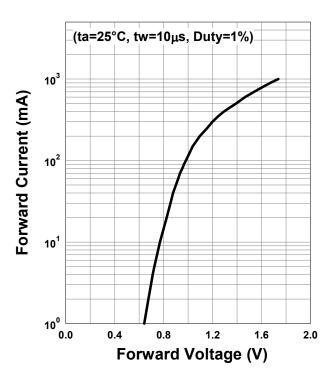
<sup>\*</sup> Measured by G8370-85.



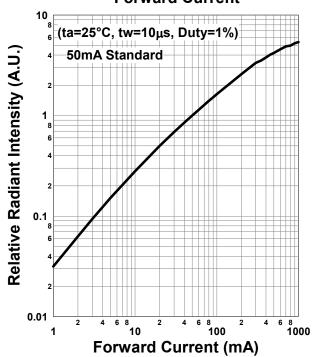
<sup>\*\*</sup> Measured by Ando Optical Multi Meter AQ2140 & AQ2742.



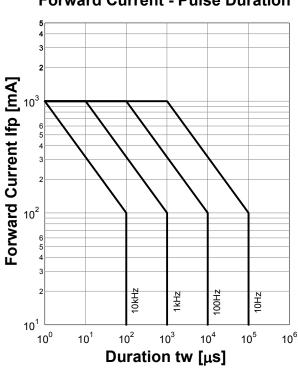
# **Forward Current - Forward Voltage**



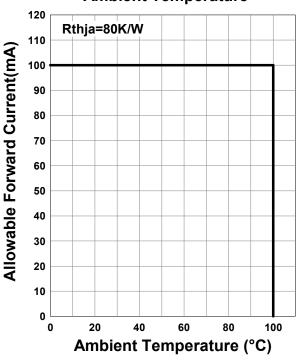
# Relative Radiant Intensity - Forward Current



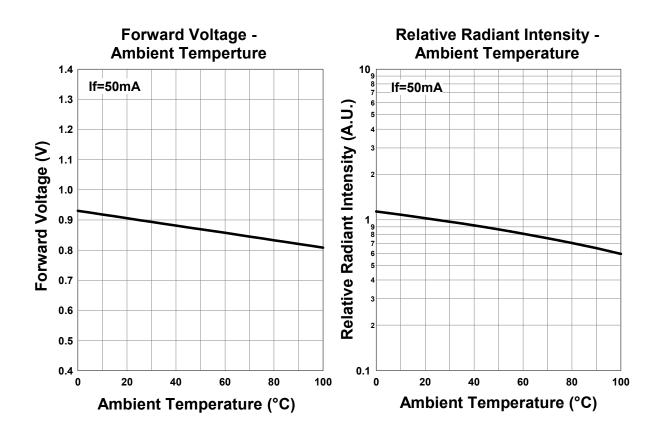
**Forward Current - Pulse Duration** 

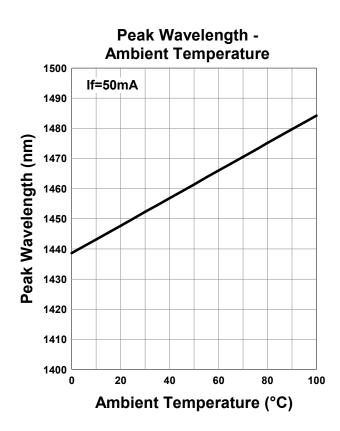


Allowable Forward Current Ambient Temperature



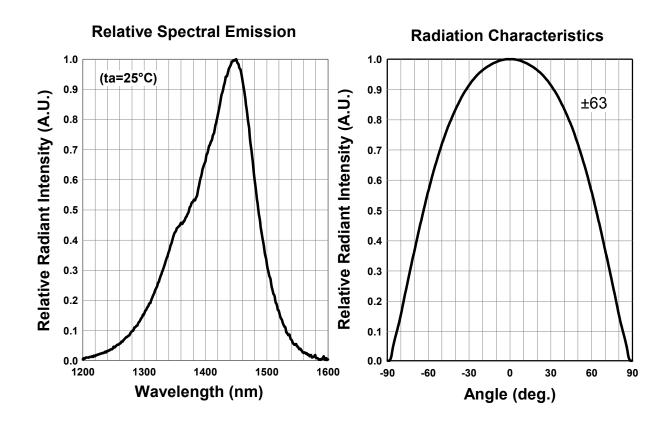


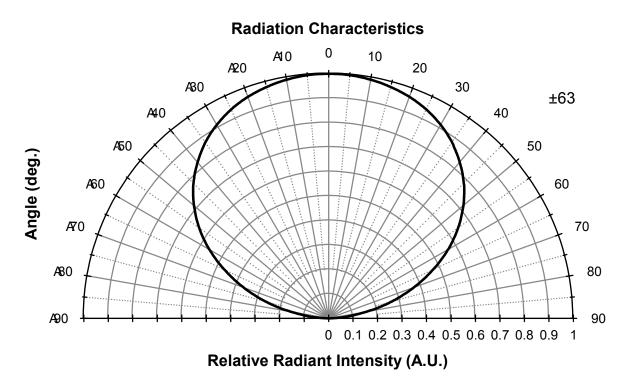




Data Sheet SMT1050









## Wrapping

Moisture barrier bag aluminum laminated film with a desiccant to keep out the moisture absorption during the transportation and storage.

# SMD LED storage and handling precautions Storage Conditions before Opening a Moisture-Barrier Aluminum Bag

- Before opening a moistureAbarrier aluminum bag, please store it at <30°C, <60%RH.</li>
- Please note that the maximum shelf life is 12 months under these conditions.

## Storage Conditions after Opening a Moisture-Barrier Aluminum Bag

- After opening a moisture-barrier aluminum bag, store the aluminum bag and silica gel in a desiccator.
- After opening the bag, please solder the LEDs within 72 hours in a room with 5 30°C, <50%RH.
- Please put any unused, remaining LEDs and silica gel back in the same aluminum bag and then vacuum Aseal the bag.
- It is recommended to keep the re-sealed bag in a desiccator at <30%RH.
- The 72-hour- long floor life does not include the time while LEDs are stored in the moisture Abarrier aluminum bag. However, we strongly recommend to solder the LEDs as soon as possible after opening the aluminum bag

### Notes about Re-sealing a Moisture-Barrier Aluminum Bag

When vacuum & sealing an opened aluminum bag, if you find the moisture-indicator of the silica
gel has changed to pink from blue (indicating a relative humidity of 30 % or more), please do not
use the unused LEDs, the aluminum bag, or the silica gel.

### Notes about Opening a Re-sealed Moisture-Barrier Aluminum Bag

 When opening a vacuumed and re-sealed aluminum bag in order to use the remaining LEDs stored in the bag, if you find that the moisture Andicator of the silica has changed to pink, please do not use the LEDs.



#### **Disclaimer**

Product specifications and data shown in this product catalog are subject to change without notice for the purposes of improving product performance, reliability, design, or otherwise.

Product data and parameters in this catalog are typical values based on reasonably up-to-date measurements. Product data and parameters may vary by user application and over time.

Products shown in this catalog are intended to be used for general electronic equipment. Products are not guaranteed for applications where product malfunction or failure may cause personal injury or death, including but not limited to life-supporting / saving devices, medical devices, safety devices, airplanes, aerospace equipment, automobiles, traffic control systems, and nuclear reactor control systems.

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